IGBT

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss.

Features

- Low Saturation Voltage using Trench with Field Stop Technology
- Low Switching Loss Reduces System Power Dissipation
- Optimized for High Speed Switching
- 5 μs Short-Circuit Capability
- These are Pb-Free Devices

Typical Applications

- Power Factor Correction
- Solar Inverters
- Uninterruptable Power Supply (UPS)

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-emitter voltage	V _{CES}	600	V
Collector current @ Tc = 25°C @ Tc = 100°C	I _C	60 30	A
Pulsed collector current, T _{pulse} limited by T _{Jmax}	I _{CM}	120	Α
Diode Forward Current @ T _C = 25°C @ T _C = 100°C	l _F	60 30	A
Diode Pulsed Current T _{pulse} Limited by T _{Jmax}	I _{FM}	120	Α
Short–circuit withstand time V_{GE} = 15 V, V_{CE} = 300 V, $T_{J} \le +150$ °C	t _{SC}	5	μs
Gate-emitter voltage Transient Gate Emitter Voltage (t _p = 5 μs, D < 0.010)	V _{GE}	±20 ±30	V
Power Dissipation @ Tc = 25°C @ Tc = 100°C	P _D	250 67	W
Operating junction temperature range	TJ	–55 to +150	°C
Storage temperature range	T _{stg}	-55 to +150	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T _{SLD}	260	°C

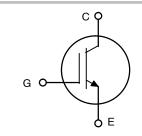
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

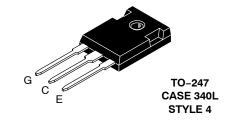


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30 A, 600 V V_{CEsat} = 1.65 V





MARKING DIAGRAM



A = Assembly Location

Y = Year WW = Work Week G = Pb-Free Package

ORDERING INFORMATION

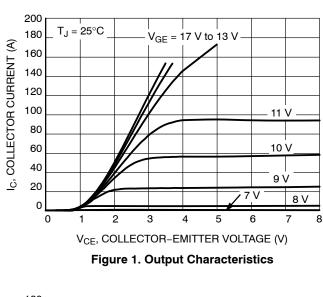
Device	Package	Shipping
NGTG30N60FLWG	TO-247 (Pb-Free)	30 Units / Rail

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ heta JC}$	0.486	°C/W
Thermal resistance junction-to-ambient	$R_{ heta JA}$	40	°C/W

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC		-		-	-	
Collector-emitter breakdown voltage, gate-emitter short-circuited	$V_{GE} = 0 \text{ V, I}_{C} = 500 \mu\text{A}$	V _{(BR)CES}	600	_	-	V
Collector-emitter saturation voltage	V _{GE} = 15 V, I _C = 30 A V _{GE} = 15 V, I _C = 30 A, T _J = 150°C	V _{CEsat}	1.4 -	1.65 2.0	1.9 -	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}, I_{C} = 200 \mu A$	V _{GE(th)}	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	V _{GE} = 0 V, V _{CE} = 600 V V _{GE} = 0 V, V _{CE} = 600 V, T _J = 150°C	I _{CES}	-	_ _	0.2 2	mA
Gate leakage current, collector-emitter short-circuited	V _{GE} = 20 V , V _{CE} = 0 V	I _{GES}	-	_	100	nA
DYNAMIC CHARACTERISTIC	•	•		•		
Input capacitance		C _{ies}	-	4200	-	pF
Output capacitance	V _{CE} = 20 V, V _{GE} = 0 V, f = 1 MHz	C _{oes}	-	130	-	1
Reverse transfer capacitance	1	C _{res}	-	110	-	1
Gate charge total		Q_g	-	170	-	nC
Gate to emitter charge	V_{CE} = 480 V, I_{C} = 30 A, V_{GE} = 15 V	Q _{ge}	_	34	-	1
Gate to collector charge]	Q _{gc}	-	83	-]
SWITCHING CHARACTERISTIC, INDUC	TIVE LOAD	•		•		
Turn-on delay time		t _{d(on)}	-	83	-	ns
Rise time	1	t _r	-	31	-	1
Turn-off delay time	Т _Ј = 25°С	t _{d(off)}	_	170	-	1
Fall time	$V_{CC} = 400 \text{ V, I}_{C} = 30 \text{ A}$ $R_{g} = 10 \Omega$	t _f	_	80	-	1
Turn-on switching loss	V _{GE} = 0 V/ 15 V	E _{on}	-	0.7	-	mJ
Turn-off switching loss]	E _{off}	-	0.28	-	
Total switching loss]	E _{ts}	-	0.98	-	
Turn-on delay time		t _{d(on)}	-	81	-	ns
Rise time]	t _r	-	32	-]
Turn-off delay time	T _J = 150°C	t _{d(off)}	-	180	-	
Fall time	$V_{CC} = 400 \text{ V}, I_{C} = 30 \text{ A}$ $R_{g} = 10 \Omega$	t _f	-	110	-	<u> </u>
Turn-on switching loss	V _{GE} = 0 V/ 15 V	E _{on}	ı	0.82	-	mJ
Turn-off switching loss		E _{off}	ı	0.63	-	
Total switching loss]	E _{ts}	-	1.45	-	



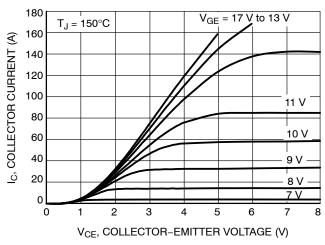
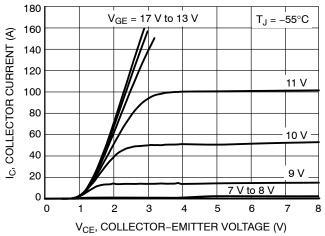


Figure 2. Output Characteristics



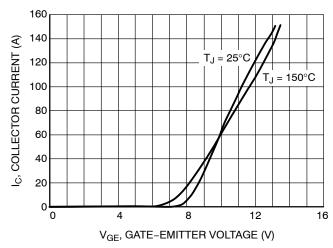
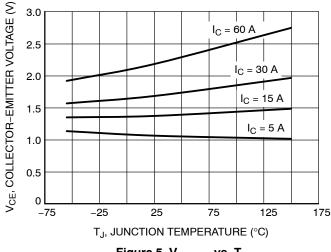


Figure 3. Output Characteristics

Figure 4. Typical Transfer Characteristics



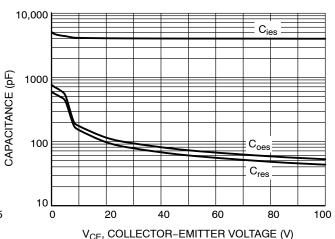


Figure 5. V_{CE(sat)} vs. T_J

Figure 6. Typical Capacitance

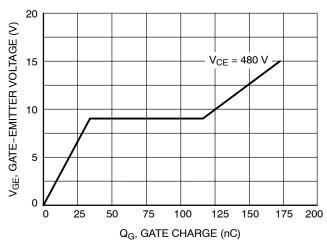


Figure 7. Typical Gate Charge

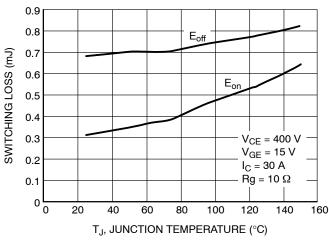


Figure 8. Switching Loss vs. Temperature

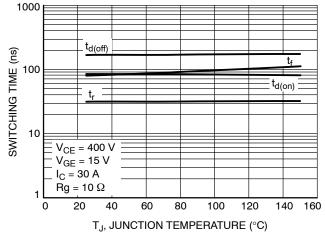


Figure 9. Switching Time vs. Temperature

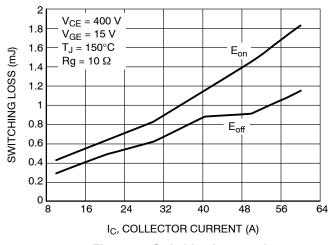


Figure 10. Switching Loss vs. I_C

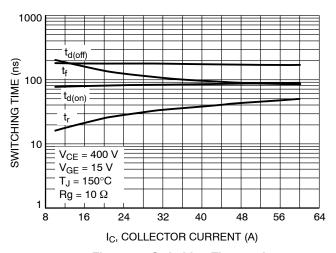
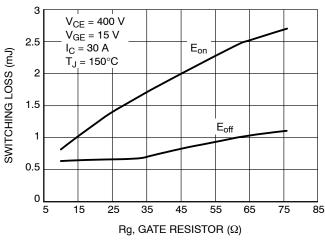


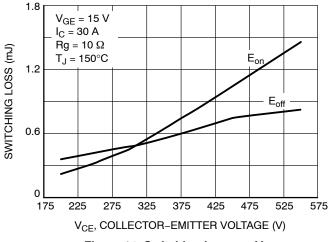
Figure 11. Switching Time vs. I_C



1000 t_{d(off)} SWITCHING TIME (ns) 100 10 V_{CE} = 400 V $V_{GE}^{-} = 15 \text{ V}$ I_C = 30 A $T_J = 150^{\circ}C$ 5 15 25 35 45 65 Rg, GATE RESISTOR (Ω)

Figure 12. Switching Loss vs. Rg

Figure 13. Switching Time vs. Rg



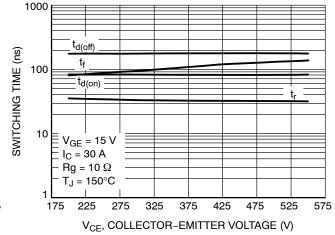
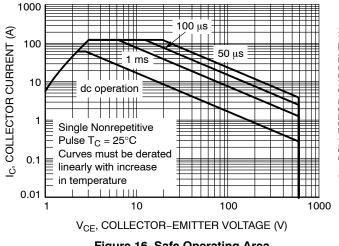


Figure 14. Switching Loss vs. V_{CE}

Figure 15. Switching Time vs. V_{CE}



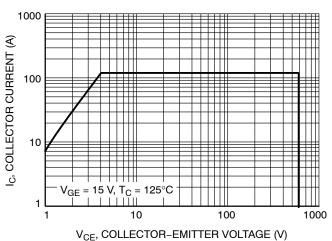


Figure 16. Safe Operating Area

Figure 17. Reverse Bias Safe Operating Area

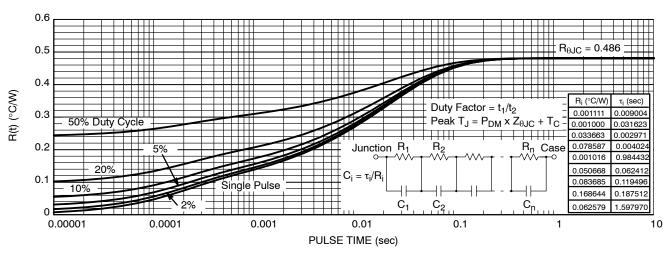


Figure 18. IGBT Transient Thermal Impedance

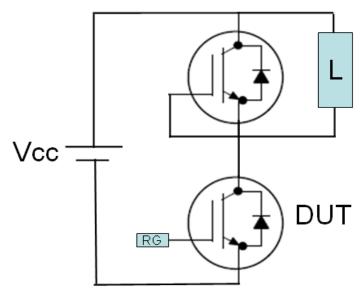


Figure 19. Test Circuit for Switching Characteristics

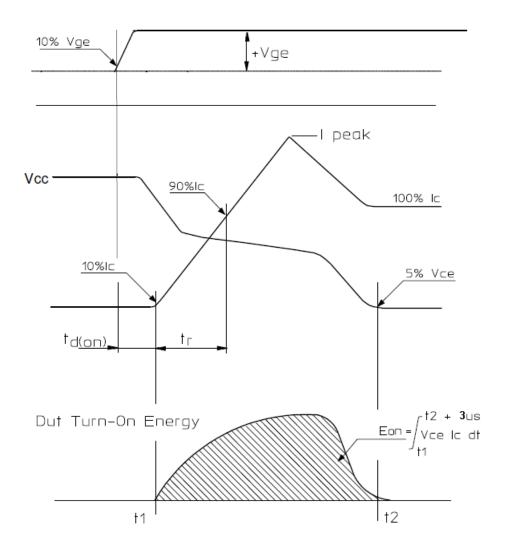


Figure 20. Definition of Turn On Waveform

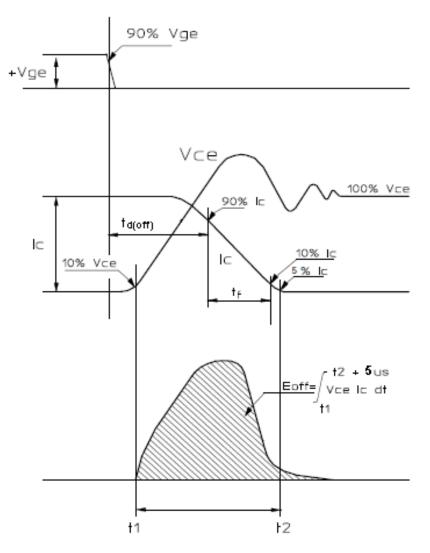
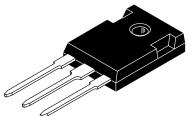


Figure 21. Definition of Turn Off Waveform





TO-247 CASE 340L ISSUE G

DATE 06 OCT 2021

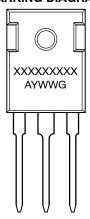
NOTES

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER

	MILLIMETERS		INC	HES
DIM	MIN.	MAX.	MIN.	MAX.
Α	20.32	21.08	0.800	0.830
В	15.75	16.26	0.620	0.640
С	4.70	5.30	0.185	0.209
D	1.00	1.40	0.040	0.055
Ε	1.90	2.60	0.075	0.102
F	1.65	2.13	0.065	0.084
G	5.45 BSC		0.215 BSC	
Н	1.50	2.49	0.059	0.098
J	0.40	0.80	0.016	0.031
К	19.81	20.83	0.780	0.820
L	5.40	6.20	0.212	0.244
N	4.32	5.49	0.170	0.216
Р		4.50		0.177
Q	3.55	3.65	0.140	0.144
U	6.15	6.15 BSC		BSC
W	2.87	3.12	0.113	0.123

⊕ 0.25 (0.010)**W** Y AS

GENERIC MARKING DIAGRAM*



STYLE 1:	STYLE 2:	STYLE 3: PIN 1. BASE 2. COLLECTOR 3. EMITTER 4. COLLECTOR	STYLE 4:
PIN 1. GATE	PIN 1. ANODE		PIN 1. GATE
2. DRAIN	2. CATHODE (S)		2. COLLECTOR
3. SOURCE	3. ANODE 2		3. EMITTER
4. DRAIN	4. CATHODES (S)		4. COLLECTOR

PIN 1. MAIN TERMINAL 1 2. MAIN TERMINAL 2

3. GATE 4. MAIN TERMINAL 2 XXXXX = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week
G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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STYLE 5: PIN 1. CATHODE

2. ANODE

3. GATE 4. ANODE

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